HVL144A

Silicon Epitaxial Trench Pin Diode for Antenna Switching

HITACHI

ADE-208-1594 (Z)

Rev.0 Sep. 2002

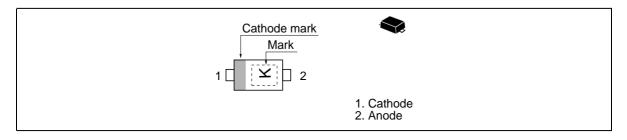
Features

- Adopting the trench structure improves low capacitance. (C = 0.43 pF max)
- Low forward resistance. (rf = $1.8 \Omega \text{ max}$)
- Low operation current.
- Extremely small Flat Package (EFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVL144A	K	EFP

Pin Arrangement





HVL144A

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Reverse voltage	V _R	30	V
Forward current	I _F	100	mA
Power dissipation	Pd	100	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Electrical Characteristics

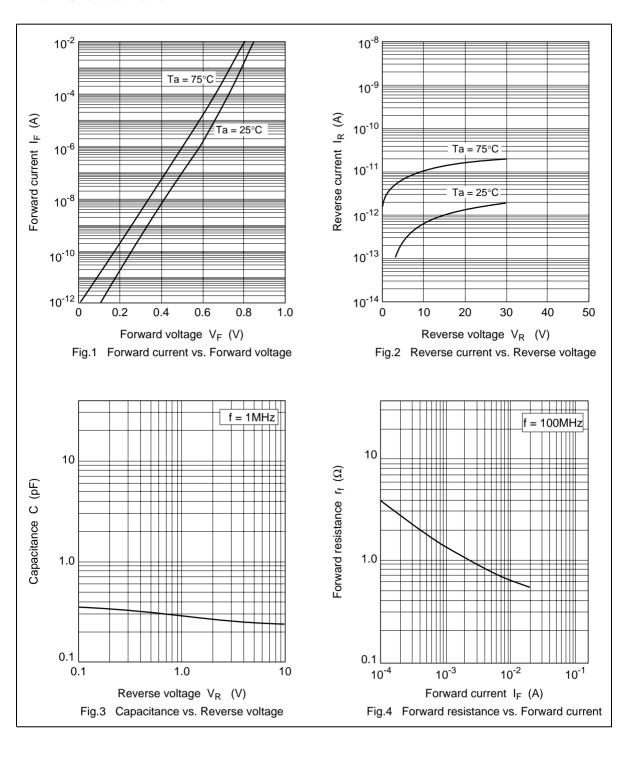
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I _R	_	_	100	nA	V _R = 30 V
Forward voltage	V _F	_	_	0.9	V	I _F = 2 mA
Capacitance	С	_	_	0.43	pF	V _R = 1 V, f = 1 MHz
Forward resistance	r _f	_	_	1.8	Ω	I _F = 2 mA, f = 100 MHz
ESD-Capability *1	_	100	_	_	V	C = 200 pF, R = 0 Ω , Both forward and reverse direction 1 pulse.

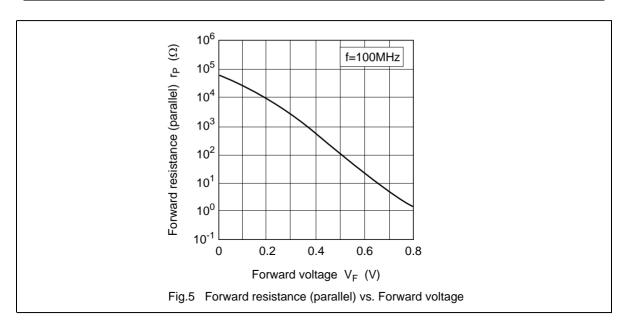
Notes: 1. Failure criterion; $I_R > 100 \text{ nA}$ at $V_R = 30 \text{ V}$

- 2. Please do not use the soldering iron due to avoid high stress to the EFP package.
- 3. The material of lead is exposed for cutting plane. Therefor, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

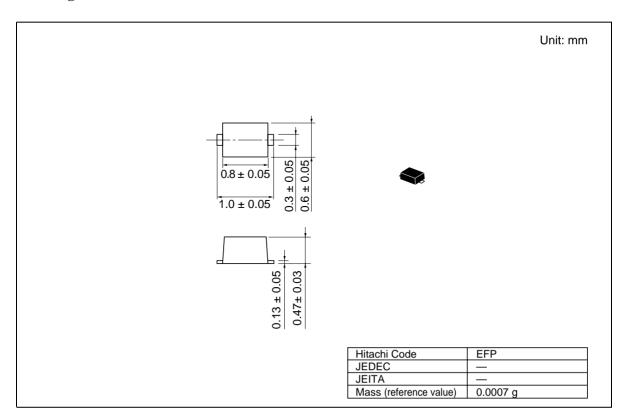
Main Characteristic



HVL144A



Package Dimensions



HVI.144A

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